



BC846AW - BC848CW

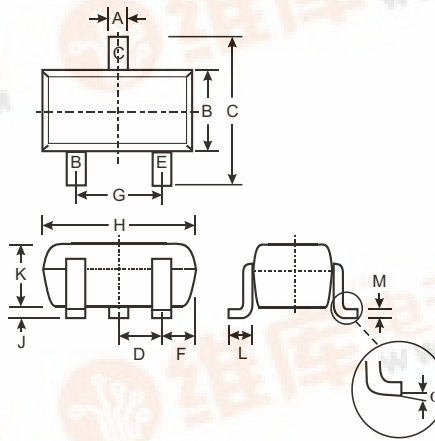
NPN SURFACE MOUNT SMALL SIGNAL TRANSISTOR

Features

Ideally Suited for Automatic Insertion
Complementary PNP Types Available (BC856W-BC858W)
For Switching and AF Amplifier Applications
Lead Free/RoHS Compliant (Note 3)
"Green" Device (Note 4 and 5)

Mechanical Data

Case: SOT-323
Case Material: Molded Plastic, "Green" Molding Compound, Note 5. UL Flammability Classification Rating 94V-0
Moisture Sensitivity: Level 1 per J-STD-020C
Terminals: Solderable per MIL-STD-202, Method 208
Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
Pin Connections: See Diagram
Marking Codes (See Table Below & Diagram on Page 2)
Ordering & Date Code Information: See Page 2
Weight: 0.006 grams (approximate)



SOT-323		
Dim	Min	Max
A	0.25	0.40
B	1.15	1.35
C	2.00	2.20
D	0.65 Nominal	
E	0.30	0.40
G	1.20	1.40
H	1.80	2.20
J	0.0	0.10
K	0.90	1.00
L	0.25	0.40
M	0.10	0.18
	0	8
All Dimensions in mm		

Marking Code (Note 2)

Type	Marking	Type	Marking
BC846AW	K1Q	BC847CW	K1M
BC846BW	K1R	BC848AW	K1J, K1E, K1Q
BC847AW	K1E, K1Q	BC848BW	K1K, K1F, K1R
BC847BW	K1F, K1R	BC848CW	K1L, K1M

Maximum Ratings @ T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	BC846 BC847 BC848 V _{CB0}	80 50 30	V
Collector-Emitter Voltage	BC846 BC847 BC848 V _{CEO}	65 45 30	V
Emitter-Base Voltage	BC846, BC847 BC848 V _{EBO}	6.0 5.0	V
Collector Current	I _C	100	mA
Peak Collector Current	I _{CM}	200	mA
Peak Emitter Current	I _{EM}	200	mA
Power Dissipation (Note 1)	P _d	200	mW
Thermal Resistance, Junction to Ambient (Note 1)	R _{JA}	625	°C/W
Operating and Storage Temperature Range	T _j , T _{STG}	-65 to +150	°C

Notes: 1. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.

2. Current gain subgroup "C" is not available for BC846W.

3. No purposefully added lead.

4. Diodes Inc.'s "Green" Policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.

5. Product manufactured with date code 0609 (week 9, 2006) and newer are built with Green Molding Compound. Product manufactured prior to date code 0609 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.



Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

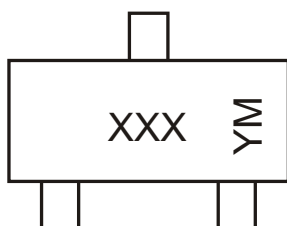
Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Base Breakdown Voltage (Note 6)	BC846 BC847 BC848 $V_{(BR)CBO}$	80 50 30	— — —	— — —	V	$I_C = 10\text{ A}$, $I_B = 0$
Collector-Emitter Breakdown Voltage (Note 6)	BC846 BC847 BC848 $V_{(BR)CEO}$	65 45 30	— — —	— — —	V	$I_C = 10\text{mA}$, $I_B = 0$
Emitter-Base Breakdown Voltage (Note 4)	BC846, BC847 BC848 $V_{(BR)EBO}$	6 5	—	—	V	$I_E = 1\text{ A}$, $I_C = 0$
DC Current Gain	Current Gain Group A B C (Note 6) h_{FE}	110 200 420	180 290 520	220 450 800	—	$V_{CE} = 5.0\text{V}$, $I_C = 2.0\text{mA}$
Collector-Emitter Saturation Voltage (Note 6)	$V_{CE(SAT)}$	—	90 200	250 600	mV	$I_C = 10\text{mA}$, $I_B = 0.5\text{mA}$ $I_C = 100\text{mA}$, $I_B = 5.0\text{mA}$
Base-Emitter Saturation Voltage (Note 6)	$V_{BE(SAT)}$	—	700 900	—	mV	$I_C = 10\text{mA}$, $I_B = 0.5\text{mA}$ $I_C = 100\text{mA}$, $I_B = 5.0\text{mA}$
Base-Emitter Voltage (Note 6)	$V_{BE(ON)}$	580 —	660 —	700 770	mV	$V_{CE} = 5.0\text{V}$, $I_C = 2.0\text{mA}$ $V_{CE} = 5.0\text{V}$, $I_C = 10\text{mA}$
Collector-Cutoff Current (Note 6)	I_{CBO} I_{CBO}	— —	— —	15 5.0	nA μA	$V_{CB} = 30\text{V}$ $V_{CB} = 30\text{V}$, $T_A = 150^\circ\text{C}$
Gain Bandwidth Product	f_T	100	300	—	MHz	$V_{CE} = 5.0\text{V}$, $I_C = 10\text{mA}$, $f = 100\text{MHz}$
Collector-Base Capacitance	C_{CBO}	—	3.0	4.5	pF	$V_{CB} = 10\text{V}$, $f = 1.0\text{MHz}$
Noise Figure	NF	—	—	10	dB	$V_{CE} = 5\text{V}$, $I_C = 200\mu\text{A}$, $R_S = 2.0\text{k}$ $f = 1.0\text{kHz}$, $f = 200\text{Hz}$

Ordering Information (Note 5 & 7)

Device	Packaging	Shipping
BC84xxW-7-F*	SOT-323	3000/Tape & Reel

*xx = device type, e.g. BC846AW-7.

- Note:
- Product manufactured with date code 0609 (week 9, 2006) and newer are built with Green Molding Compound. Product manufactured prior to date code 0609 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.
 - Short duration pulse test to minimize self-heating effect.
 - For Packaging Details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

Marking Information


XXX = Product Type Marking Code (See Page 1), e.g. K1Q = BC846AW
 YM = Date Code Marking
 Y = Year ex: N = 2002
 M = Month ex: 9 = September

Date Code Key

Year	1998	1999	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	J	K	L	M	N	P	R	S	T	U	V	W	X	Y	Z

Month	Jan	Feb	March	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

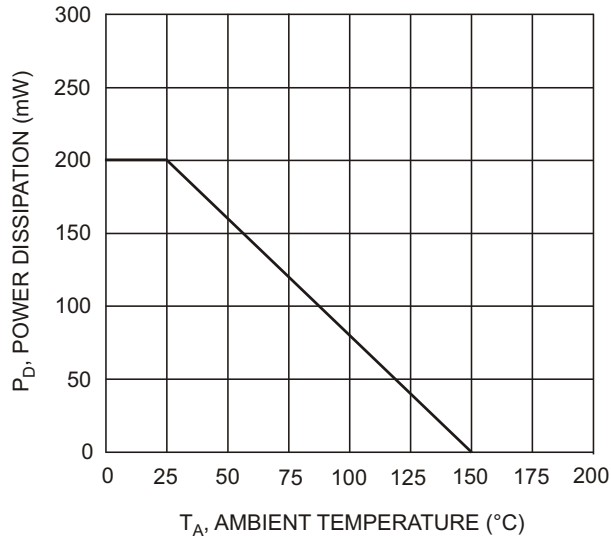


Fig. 1, Max Power Dissipation vs Ambient Temperature

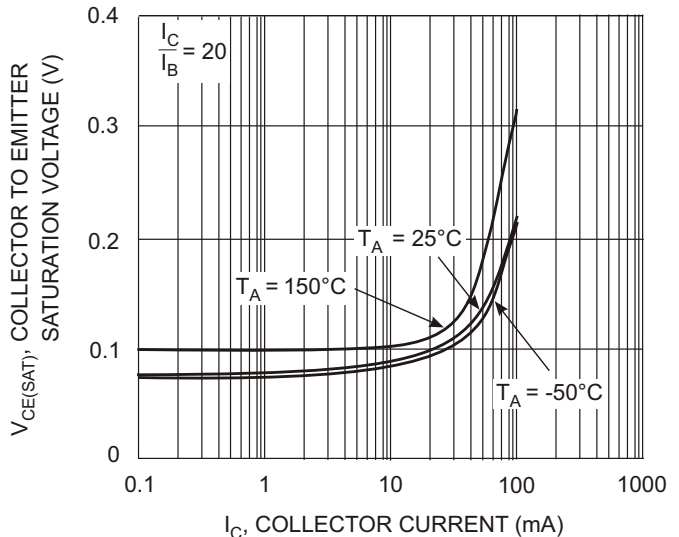


Fig. 2 Collector Emitter Saturation Voltage vs. Collector Current

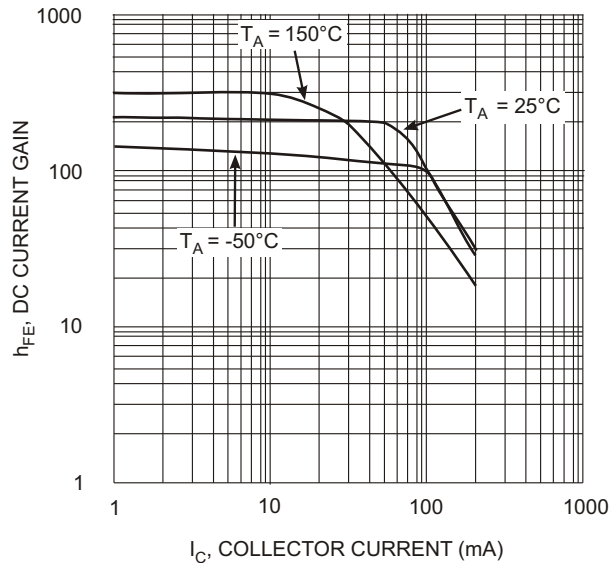


Fig. 3, DC Current Gain vs. Collector Current

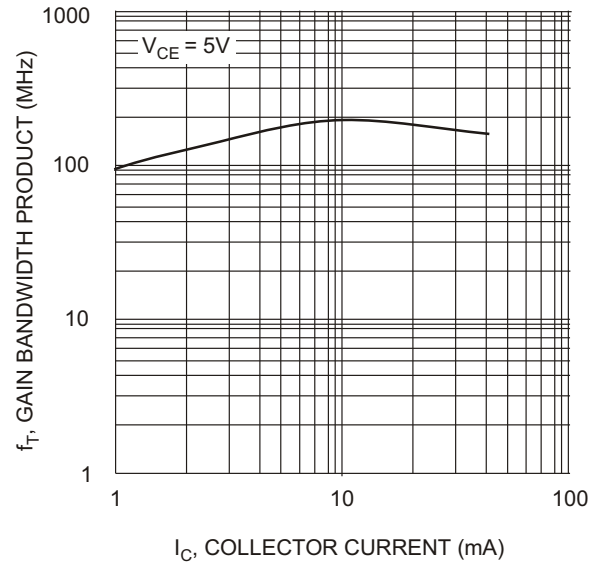


Fig. 4, Gain Bandwidth Product vs Collector Current

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